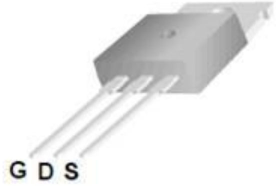
P0903BT

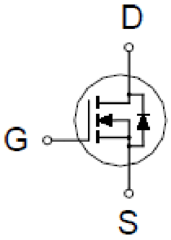
N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
30V	9.7mΩ @V_{GS} = 10V	60A



TO-220



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	30	V
Gate-Source Voltage		V_{GS}	±20	
Continuous Drain Current[2]	T_C = 25 °C	I_D	60	A
	T_C = 100 °C		38	
Pulsed Drain Current [1, 2]		I_{DM}	240	
Avalanche Current[3]		I_{AS}	34	
Avalanche Energy[3]	L = 0.1mH	E_{AS}	58	mJ
Power Dissipation	T_C = 25 °C	P_D	56	W
	T_C = 100 °C		22	
Operating Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		2.2	°C / W

[1] Pulse width limited by maximum junction temperature.

[2] Limited only by maximum temperature allowe.

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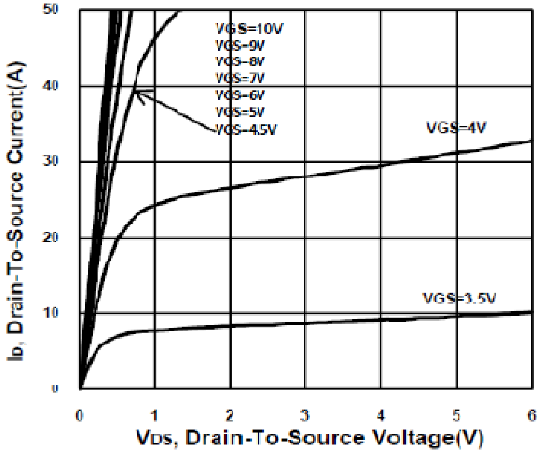
ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

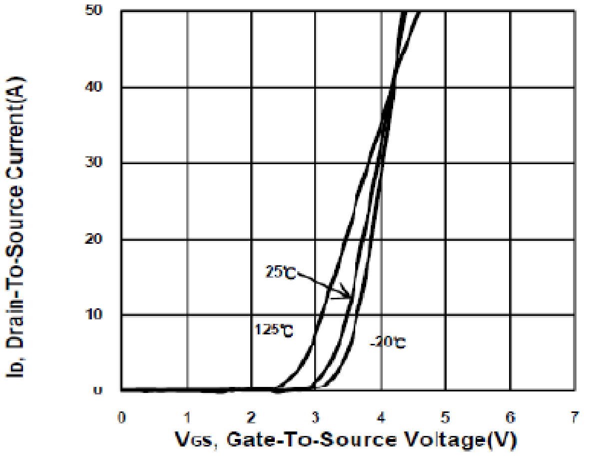
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = 250μA	30			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250μA	1.0	1.9	3.0	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0V, V_{GS} = ±20V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 24V, V_{GS} = 0V , T_C = 25 °C			1	μA
		V_{DS} = 20V, V_{GS} = 0V , T_C = 125 °C			10	
Drain-Source On-State Resistance[1]	$R_{DS(ON)}$	V_{GS} = 4.5V, I_D = 20A		14	16	mΩ
		V_{GS} = 10V, I_D = 20A		8.0	9.7	
Forward Transconductance[1]	g_{fs}	V_{DS} = 20V, I_D = 20A		37		S
DYNAMIC						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = 15V, f = 1MHz		1150		pF
Output Capacitance	C_{oss}			304		
Reverse Transfer Capacitance	C_{rss}			175		
Total Gate Charge[2]	Q_g	V_{DD} = 15V, V_{GS} = 10V, I_D = 20A		25		nC
Gate-Source Charge[2]	Q_{gs}			5		
Gate-Drain Charge[2]	Q_{gd}			8		
Turn-On Delay Time[2]	$t_{d(on)}$	V_{DD} = 15V, I_D = 20A, R_G = 6Ω		25		nS
Rise Time[2]	t_r			23		
Turn-Off Delay Time[2]	$t_{d(off)}$			35		
Fall Time[2]	t_f			44		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current[3]	I_S				60	A
Forward Voltage[1]	V_{SD}	I_F = 20A, V_{GS} = 0V			1.3	V
Reverse Recovery Time	t_{rr}	I_F = 20A, dI_F/dt = 100A / μS		23		nS
Reverse Recovery Charge	Q_{rr}			12		nC

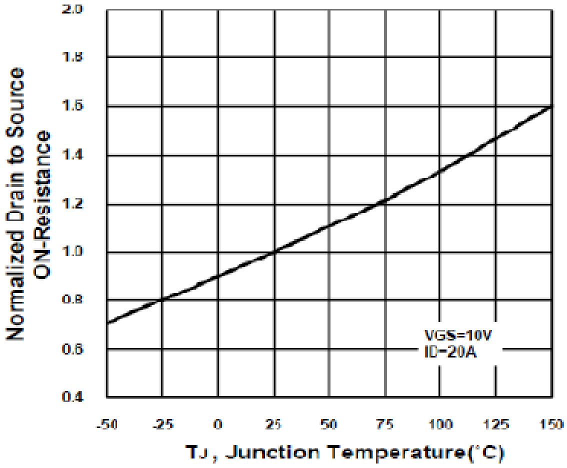
[1] Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

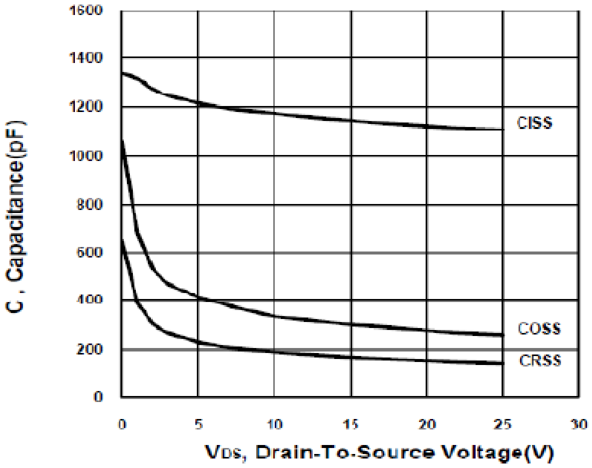
[2] Independent of operating temperature.

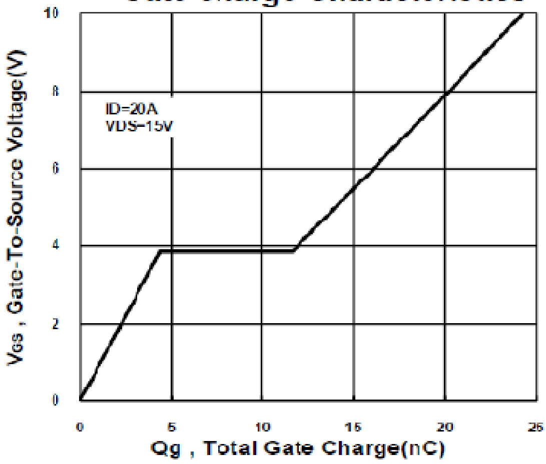
[3] Pulse width limited by maximum junction temperature.

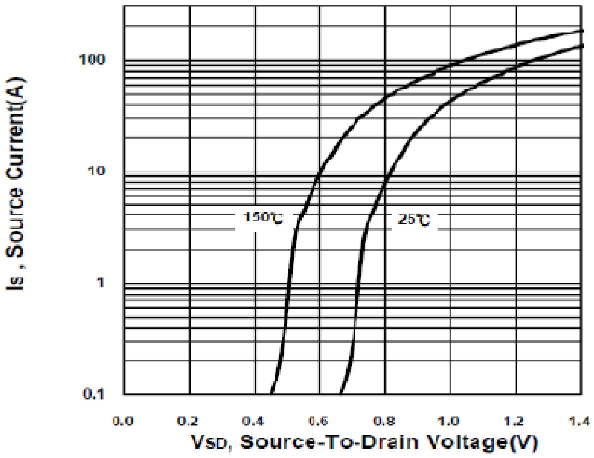

Output Characteristics

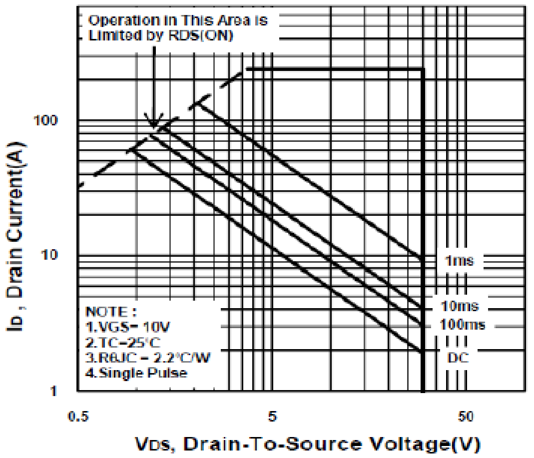

Transfer Characteristics


On-Resistance VS Temperature

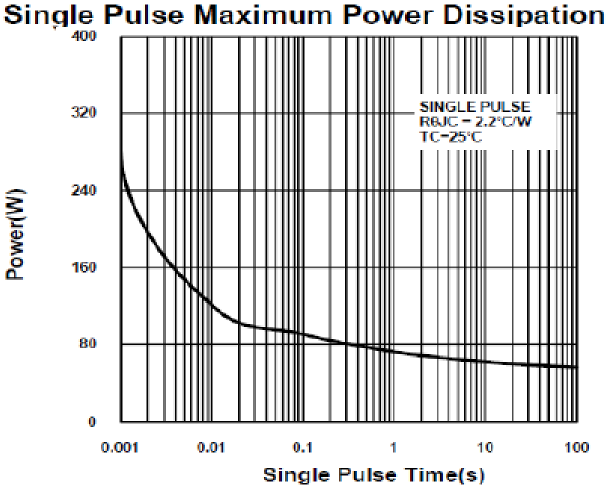

Capacitance Characteristic


Gate charge Characteristics

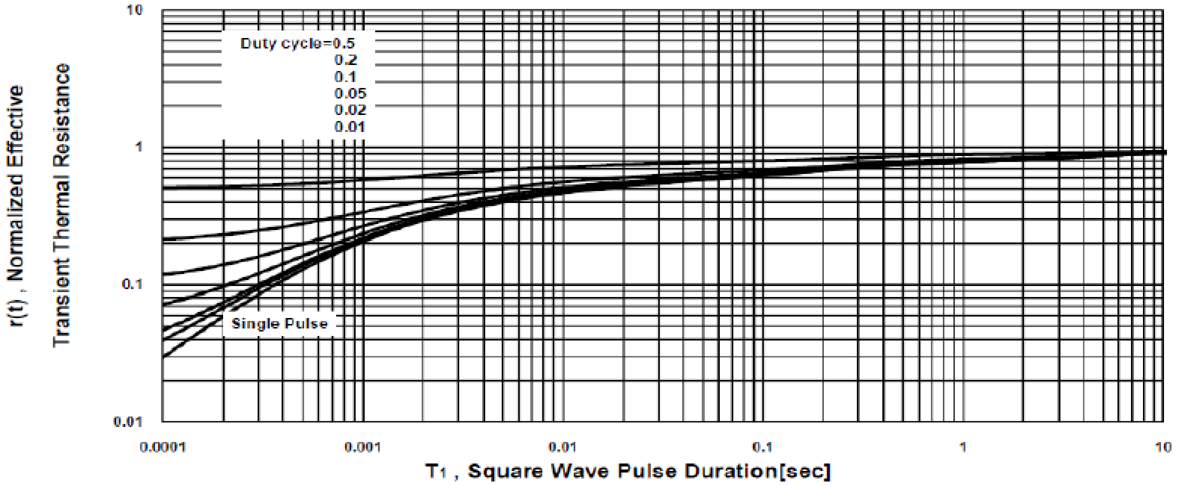

Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

Package Dimension

TO-220 (3-Lead) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	9.652	10.16	11.5	H	2.04	2.54	3.04
B	2.54	2.79	3.048	I	1.15	1.52	1.778
C	17.3		22.86	J	3.556	4.57	4.826
D	26.924	29.03	31.242	K	0.508	1.3	1.45
E	14.224	15.45	16.510	L	1.89	2.69	3.09
F	8.382	9.20	9.40	M	0.34	0.5	0.6
G	0.381	0.81	1.016	N